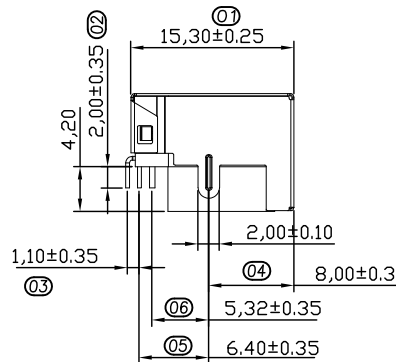
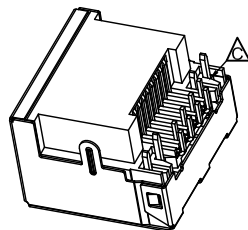
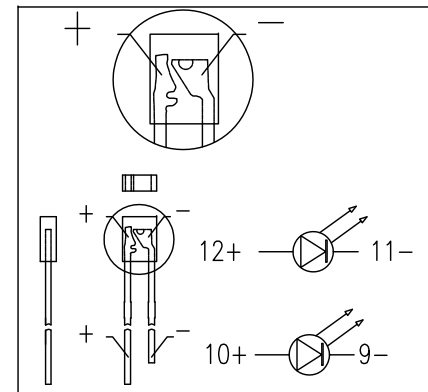
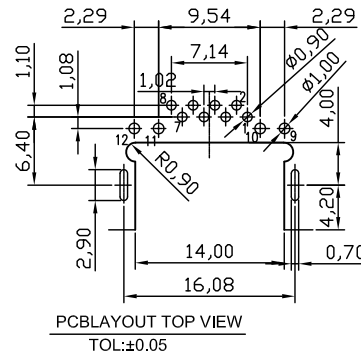
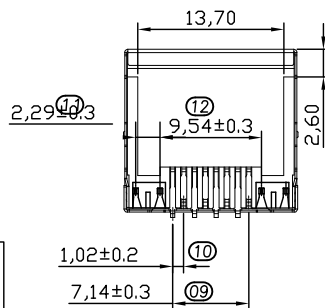
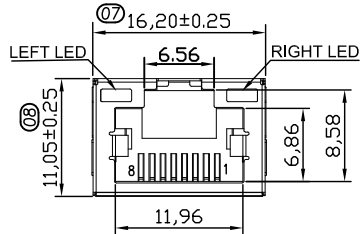


RoHS compliant



脚位尺寸以过孔规为准



NOTES:

1. HOUSING MATERIAL:GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL:COPPER ALLOY,T=0.35.
3. PLATING: GOLD PLATED ON CONTACT AREA, 100u"MIN. TIN PLATED ON SOLDERING AREA, 50u"MIN. NICKEL PLATED OVERALL.
4. SHELL:COPPER ALLOY,T=0.20. 30u"MIN. NICKEL PLATED OVERALL.
5. LED:T=0.50, TIN PLATED.

ELECTRICAL:

1. VOLTAGE RATING: 125V AC RMS.
2. CURRENT RATING: 1.5AMP.
3. CONTACT RESISTANCE: 30MILLIOHMS MAX.
4. INSULATION RESISTANCE: 500MEGOHMS MIN @500V DC.

MECHANICAL:

1. DURABILITY: 750 CYCLES MIN.
2. INSERTION FORCE : 22N MAX.
3. REMOVAL FORCE(WITHOUT PLUG LOCK) : 22N MAX.

ENVIRONMENTAL:

1. STORAGE: -40°C~85°C
2. OPERATION: 0°C~70°C

*Apply to the EU standards(ROSH)

1. 01 ~ 12 FOR QIP DIM.

P/N:RJ58D-8811-111413P

RJ45 SINK DIP SERIES PCB JACK

POSITIONS (金針位置):
8-POSITIONS (8P)
CONTACTS (金針根數):
8-CONTACTS (8C)
PORTS (端口):
11-1X1
SHIELD (屏蔽壳)
1-WITH SHIELD (有屏蔽壳)
LED STYLE (LED 顏色類型):
1-L LED: YELLOW, R LED: GREEN (左黃右綠)
2-L LED: GREEN, R LED: YELLOW (左綠右黃)

PACKING TYPE (包裝):
R-BELL (卷帶包裝)
P-PVC TRAY (盤裝)
HEIGHT (沉板高度):
3-SINK H=4.2 (沉板H=4.2)
COLOR (顏色):
1-BLACK (黑色)
PLASTIC (塑料):
4-CP
GOLD PLATING (鍍金厚度):
1-10"; 2-1.50"; 3-30"; 4-60";
5-150"; 6-300"; 7-500";

					GENERAL TOLERANCE		DRAWN		Sene Li		2018/10/22		X-SHUN 东莞市祥舜电子科技有限公司						
					.X	±0.35	X.°	± 2°	CHECKE		LM			DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD					
					.XX	±0.25	.X°	± 1°	APPROVE					PART NO.		RJ58D-8811-111413P			
A0		NEW DESIGN		2018/10/22		.XXX	±0.15	.XX°	± 0.5°					TITLE:		RJ45 8P8C DIP SINK H=4.2MM W/SHIELD W/LED			
REV	ECN NO	DESCRIPTION		DATE	SIGNATURE	PROJECT				UNIT	mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.	RJ58D-88